

FOD3180

2A Output Current, High Speed MOSFET Gate Driver Optocoupler

Features

- Guaranteed operating temperature range of -40°C to +100°C
- 2A minimum peak output current
- High speed response: 200ns max propagation delay over temperature range
- 250kHz maximum switching speed
- 30ns typ pulse width distortion
- Wide V_{CC} operating range: 10V to 20V
- 5000Vrms, 1 minute isolation
- Under voltage lockout protection (UVLO) with hysteresis
- Minimum creepage distance of 7.0mm
- Minimum clearance distance of 7.0mm
- C-UL, UL and VDE* approved
- $R_{DS(ON)}$ of 1.5 Ω (typ.) offers lower power dissipation
- 15kV/ μ s minimum common mode rejection

Applications

- Plasma Display Panel
- High performance DC/DC convertor
- High performance switch mode power supply
- High performance uninterruptible power supply
- Isolated Power MOSFET gate drive

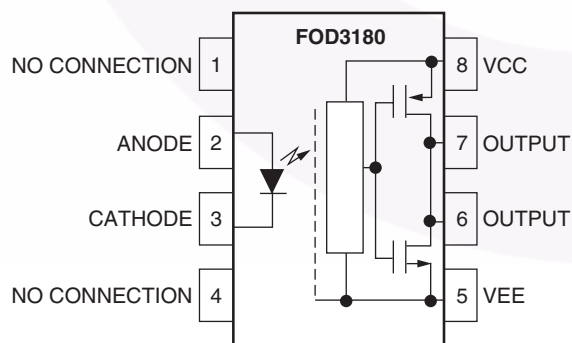
*Requires 'V' ordering option

Description

The FOD3180 is a 2A Output Current, High Speed MOSFET Gate Drive Optocoupler. It consists of a aluminium gallium arsenide (AlGaAs) light emitting diode optically coupled to a CMOS detector with PMOS and NMOS output power transistors integrated circuit power stage. It is ideally suited for high frequency driving of power MOSFETs used in Plasma Display Panels (PDPs), motor control inverter applications and high performance DC/DC converters.

The device is packaged in an 8-pin dual in-line housing compatible with 260°C reflow processes for lead free solder compliance.

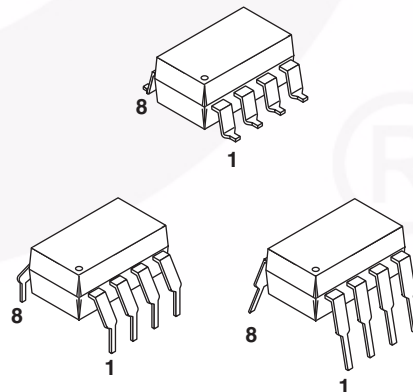
Functional Block Diagram



Note:

A 0.1 μ F bypass capacitor must be connected between pins 5 and 8.

Package Outlines



Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Value	Units
T_{STG}	Storage Temperature	-40 to +125	$^\circ\text{C}$
T_{OPR}	Operating Temperature	-40 to +100	$^\circ\text{C}$
T_J	Junction Temperature	-40 to +125	$^\circ\text{C}$
T_{SOL}	Lead Solder Temperature	260 for 10 sec.	$^\circ\text{C}$
$I_{F(AVG)}$	Average Input Current ⁽¹⁾	25	mA
$I_{F(tr, tf)}$	LED Current Minimum Rate of Rise/Fall	250	ns
$I_{F(TRAN)}$	Peak Transient Input Current (<1 μs pulse width, 300pps)	1.0	A
V_R	Reverse Input Voltage	5	V
$I_{OH(PEAK)}$	“High” Peak Output Current ⁽²⁾	2.5	A
$I_{OL(PEAK)}$	“Low” Peak Output Current ⁽²⁾	2.5	A
$V_{CC} - V_{EE}$	Supply Voltage	-0.5 to 25	V
$V_{O(PEAK)}$	Output Voltage	0 to V_{CC}	V
P_O	Output Power Dissipation ⁽⁴⁾	250	mW
P_D	Total Power Dissipation ⁽⁵⁾	295	mW

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Value	Units
$V_{CC} - V_{EE}$	Power Supply	10 to 20	V
$I_{F(ON)}$	Input Current (ON)	10 to 16	mA
$V_{F(OFF)}$	Input Voltage (OFF)	-3.0 to 0.8	V

Electrical-Optical Characteristics (DC)

Over recommended operating conditions unless otherwise specified.

Symbol	Parameter	Test Conditions	Min.	Typ.*	Max.	Unit
I_{OH}	High Level Output Current ⁽²⁾⁽³⁾	$V_{OH} = (V_{CC} - V_{EE} - 1V)$	0.5			A
		$V_{OH} = (V_{CC} - V_{EE} - 3V)$	2.0			
I_{OL}	Low Level Output Current ⁽²⁾⁽³⁾	$V_{OL} = (V_{CC} - V_{EE} - 1V)$	0.5			A
		$V_{OL} = (V_{CC} - V_{EE} - 3V)$	2.0			
V_{OH}	High Level Output Voltage ⁽⁶⁾⁽⁷⁾	$I_O = -100mA$	$V_{CC} - 0.5$			V
V_{OL}	Low Level Output Voltage ⁽⁶⁾⁽⁷⁾	$I_O = 100mA$			$V_{EE} + 0.5$	V
I_{CCH}	High Level Supply Current	Output Open, $I_F = 10$ to $16mA$		4.8	6.0	mA
I_{CCL}	Low Level Supply Current	Output Open, $V_F = -3.0$ to $0.8V$		5.0	6.0	mA
I_{FLH}	Threshold Input Current Low to High	$I_O = 0mA$, $V_O > 5V$			8.0	mA
V_{FHL}	Threshold Input Voltage High to Low	$I_O = 0mA$, $V_O < 5V$	0.8			V
V_F	Input Forward Voltage	$I_F = 10mA$	1.2	1.43	1.8	V
$\Delta V_F / T_A$	Temperature Coefficient of Forward Voltage	$I_F = 10mA$		-1.5		mV/°C
V_{UVLO+}	UVLO Threshold	$V_O > 5V$, $I_F = 10mA$		8.3		V
V_{UVLO-}		$V_O < 5V$, $I_F = 10mA$		7.7		V
$UVLO_{HYST}$	UVLO Hysteresis			0.6		V
BV_R	Input Reverse Breakdown Voltage	$I_R = 10\mu A$	5			V
C_{IN}	Input Capacitance	$f = 1MHz$, $V_F = 0V$		60		pF

*Typical values at $T_A = 25^\circ C$

Switching Characteristics

Over recommended operating conditions unless otherwise specified.

Symbol	Parameter	Test Conditions	Min.	Typ.*	Max.	Unit
t_{PLH}	Propagation Delay Time to High Output Level ⁽⁸⁾	$I_F = 10\text{mA}$, $R_g = 10\Omega$, $f = 250\text{kHz}$, Duty Cycle = 50%, $C_g = 10\text{nF}$	50	135	200	ns
t_{PHL}	Propagation Delay Time to Low Output Level ⁽⁸⁾		50	105	200	ns
P_{WD}	Pulse Width Distortion ⁽⁹⁾				65	ns
P_{DD} ($t_{PHL} - t_{PLH}$)	Propagation Delay Difference Between Any Two Parts ⁽¹⁰⁾		-90		90	ns
t_r	Rise Time	$C_L = 10\text{nF}$, $R_g = 10\Omega$		75		ns
t_f	Fall Time			55		ns
$t_{UVLO\ ON}$	UVLO Turn On Delay			2.0		μs
$t_{UVLO\ OFF}$	UVLO Turn Off Delay			0.3		μs
$ CM_H $	Output High Level Common Mode Transient Immunity ^{(11) (12)}	$T_A = +25^\circ\text{C}$, $I_f = 10$ to 16mA , $V_{CM} = 1.5\text{kV}$, $V_{CC} = 20\text{V}$	15			$\text{kV}/\mu\text{s}$
$ CM_L $	Output Low Level Common Mode Transient Immunity ^{(11) (13)}	$T_A = +25^\circ\text{C}$, $V_f = 0\text{V}$, $V_{CM} = 1.5\text{kV}$, $V_{CC} = 20\text{V}$	15			$\text{kV}/\mu\text{s}$

*Typical values at $T_A = 25^\circ\text{C}$

Isolation Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.*	Max.	Unit
V_{ISO}	Withstand Isolation Voltage ^{(14) (15)}	$T_A = 25^\circ\text{C}$, R.H. < 50%, $t = 1\text{min.}$, $I_{I-O} \leq 20\mu\text{A}$	5000			V_{rms}
R_{I-O}	Resistance (input to output) ⁽¹⁵⁾	$V_{I-O} = 500\text{V}$		10^{11}		Ω
C_{I-O}	Capacitance (input to output)	Freq. = 1MHz		1		pF

*Typical values at $T_A = 25^\circ\text{C}$

Notes:

1. Derate linearly above +70°C free air temperature at a rate of 0.3mA/°C.
2. The output currents I_{OH} and I_{OL} are specified with a capacitive current limited load = $(3 \times 0.01\mu F) + 0.5\Omega$, frequency = 8kHz, 50% DF.
3. The output currents I_{OH} and I_{OL} are specified with a capacitive current limited load = $(3 \times 0.01\mu F) + 8.5\Omega$, frequency = 8kHz, 50% DF.
4. Derate linearly above +87°C, free air temperature at the rate of 0.77mW/°C. Refer to Figure 12.
5. No derating required across operating temperature range.
6. In this test, V_{OH} is measured with a dc load current of 100mA. When driving capacitive load V_{OH} will approach V_{CC} as I_{OH} approaches zero amps.
7. Maximum pulse width = 1ms, maximum duty cycle = 20%.
8. t_{PHL} propagation delay is measured from the 50% level on the falling edge of the input pulse to the 50% level of the falling edge of the V_O signal. t_{PLH} propagation delay is measured from the 50% level on the rising edge of the input pulse to the 50% level of the rising edge of the V_O signal.
9. PWD is defined as $|t_{PHL} - t_{PLH}|$ for any given device.
10. The difference between t_{PHL} and t_{PLH} between any two FOD3180 parts under same test conditions.
11. Pin 1 and 4 need to be connected to LED common.
12. Common mode transient immunity in the high state is the maximum tolerable dV_{CM}/dt of the common mode pulse V_{CM} to assure that the output will remain in the high state (i.e. $V_O > 10.0V$).
13. Common mode transient immunity in a low state is the maximum tolerable dV_{CM}/dt of the common mode pulse, V_{CM} , to assure that the output will remain in a low state (i.e. $V_O < 1.0V$).
14. In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage > 6000Vrms, 60Hz for 1 second (leakage detection current limit $I_{L-O} < 5\mu A$).
15. Device considered a two-terminal device: pins on input side shorted together and pins on output side shorted together.

Typical Performance Curves

Fig. 1 Input Forward Current vs. Forward Voltage

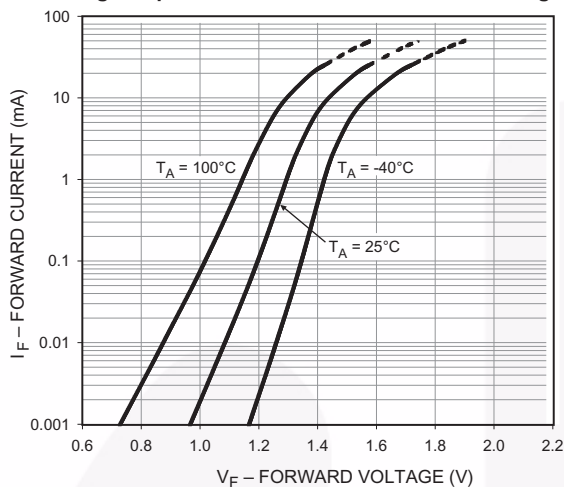


Fig. 2 Low To High Input Current Threshold vs. Ambient Temperature

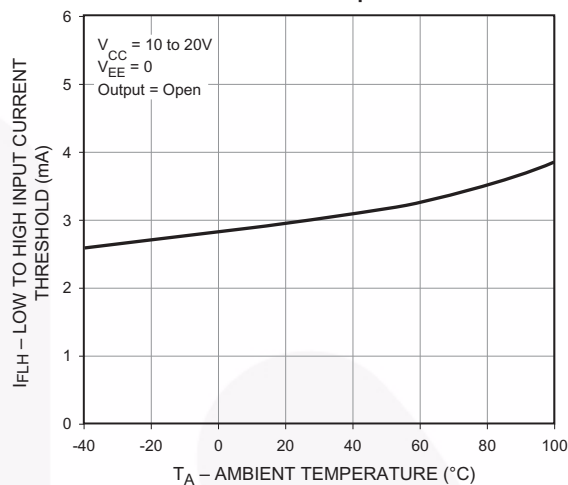


Fig. 3 Output Low Voltage vs. Ambient Temperature

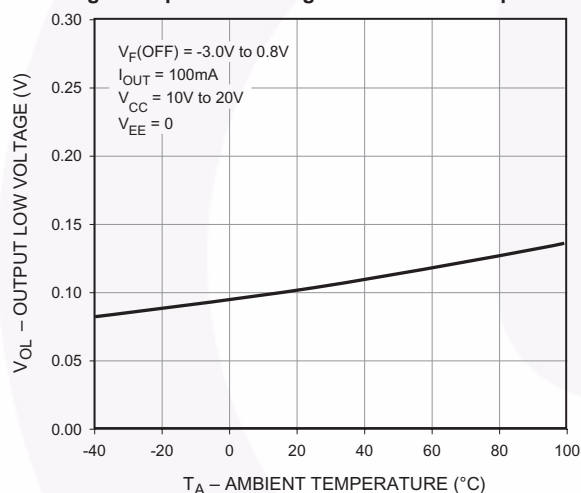


Fig. 4 High Output Voltage Drop vs. Ambient Temperature

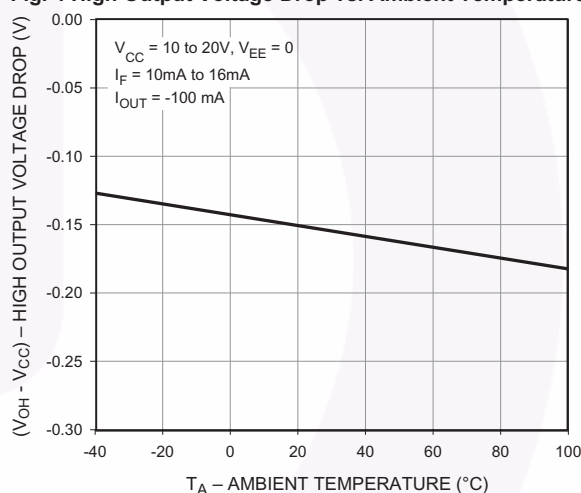


Fig. 5 Supply Current vs. Ambient Temperature

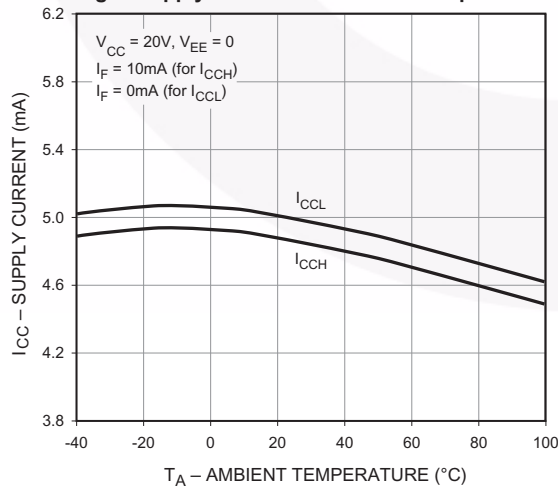
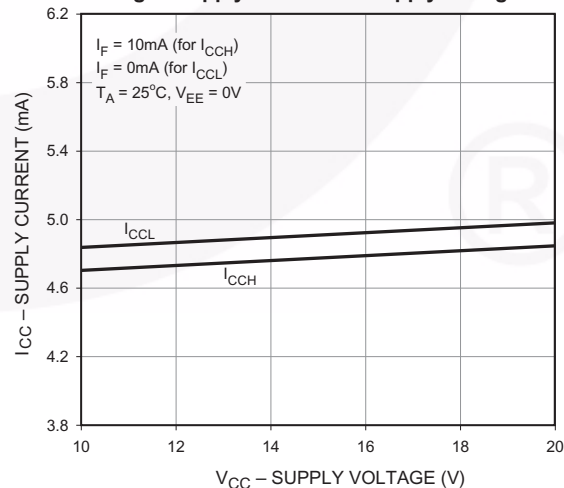


Fig. 6 Supply Current vs. Supply Voltage



Typical Performance Curves (Continued)

Fig. 7 Propagation Delay vs. Load Capacitance

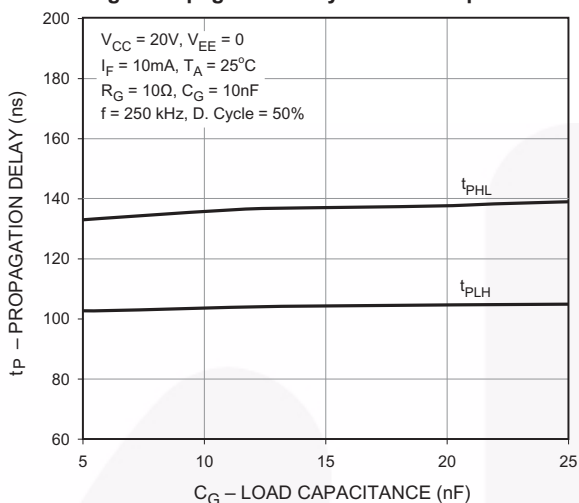


Fig. 8 Propagation Delay vs. Forward LED Current

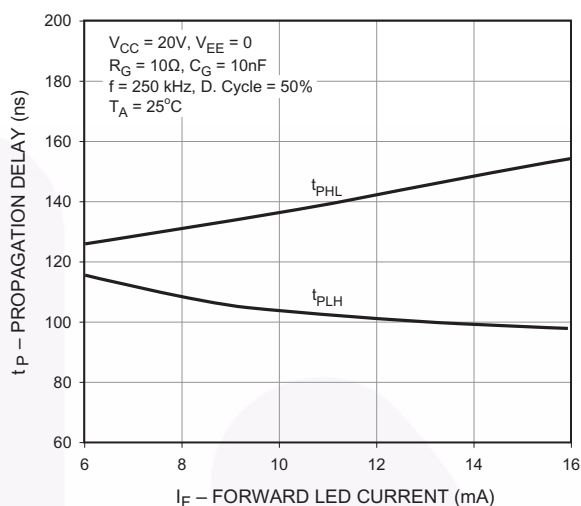


Fig. 9 Propagation Delay vs. Series Load Resistance

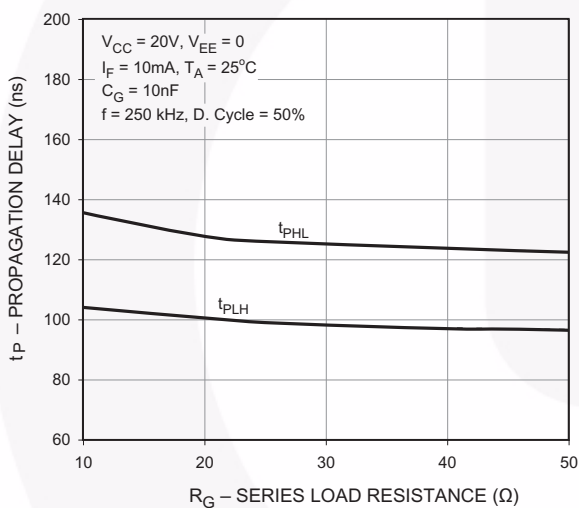


Fig. 10 Propagation Delay vs. Ambient Temperature

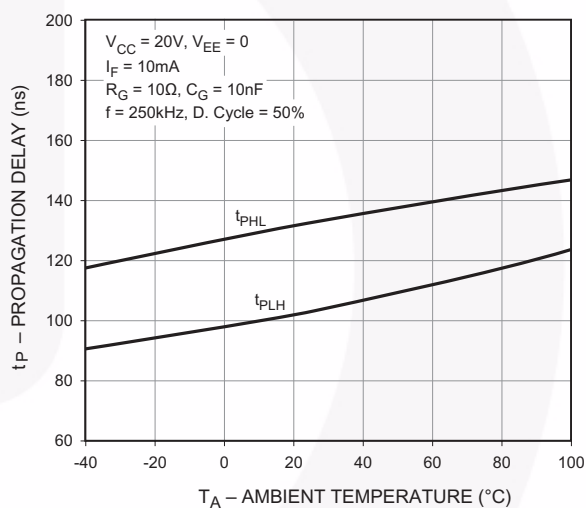
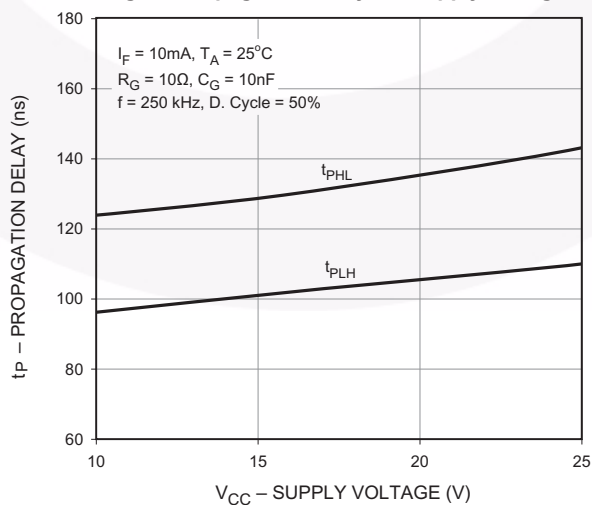
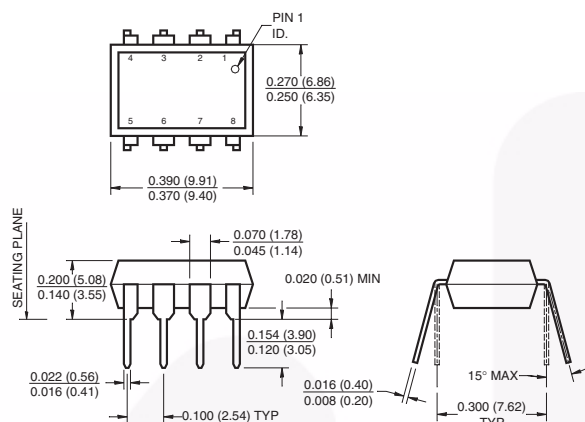


Fig. 11 Propagation Delay vs. Supply Voltage

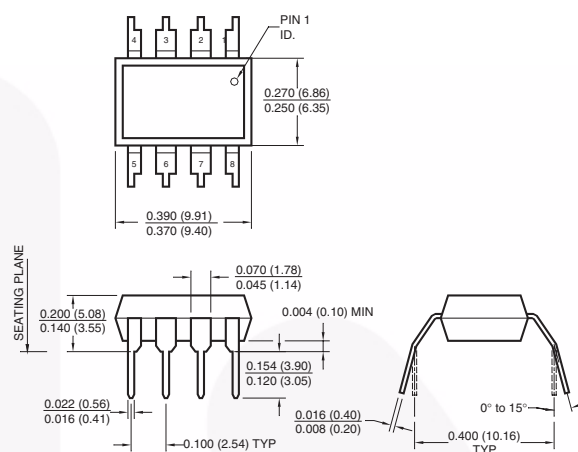


Package Dimensions

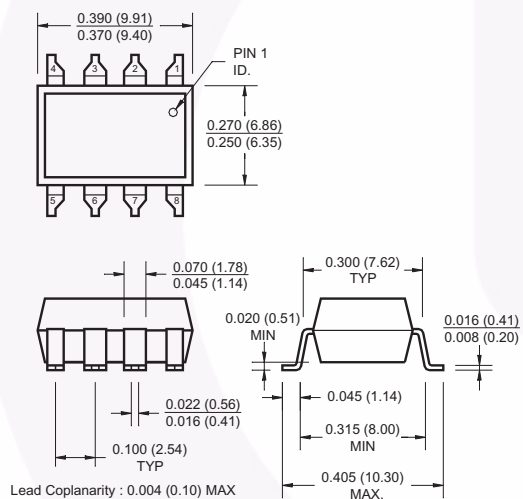
Through Hole



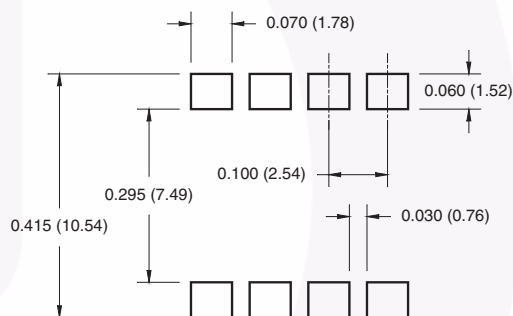
0.4" Lead Spacing



Surface Mount



8-Pin DIP – Land Pattern



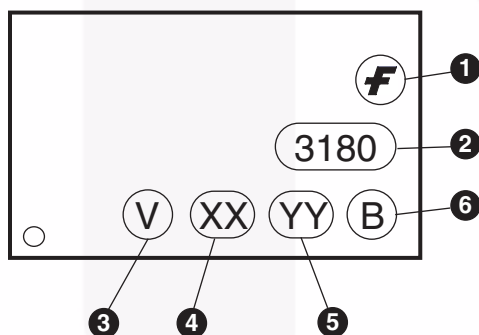
Note:

All dimensions are in inches (millimeters)

Ordering Information

Option	Order Entry Identifier (Example)	Description
No option	FOD3180	Standard Through Hole Device
S	FOD3180S	Surface Mount, Lead Bend
SD	FOD3180SD	Surface Mount, Tape and Reel
T	FOD3180T	0.4" Lead Spacing
V	FOD3180V	VDE 0884
TV	FOD3180TV	VDE 0884, 0.4" Lead Spacing
SV	FOD3180SV	VDE 0884, Surface Mount
SDV	FOD3180SDV	VDE 0884, Surface Mount, Tape and Reel

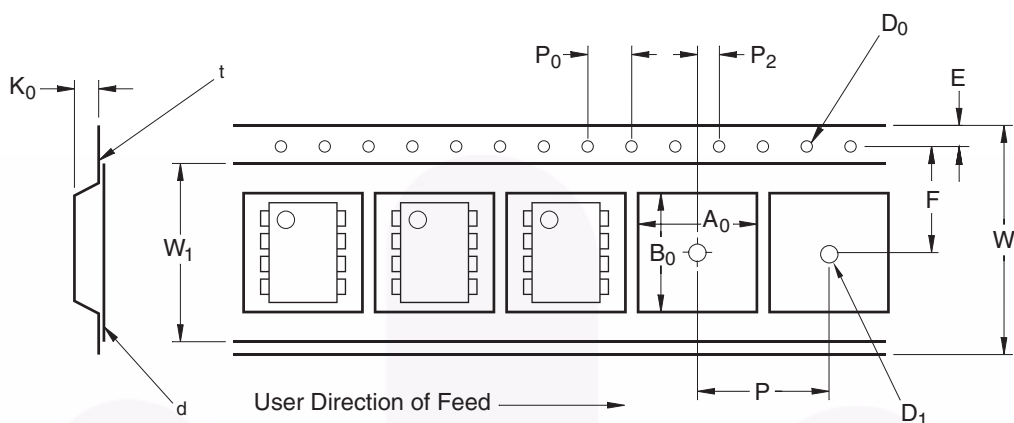
Marking Information



Definitions

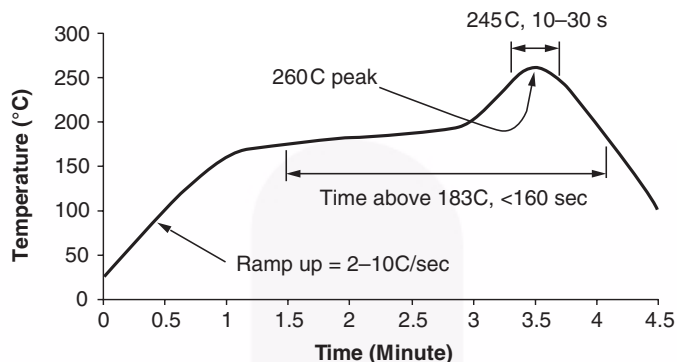
1	Fairchild logo
2	Device number
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)
4	Two digit year code, e.g., '03'
5	Two digit work week ranging from '01' to '53'
6	Assembly package code

Carrier Tape Specifications



Symbol	Description	Dimension in mm
W	Tape Width	16.0 ± 0.3
t	Tape Thickness	0.30 ± 0.05
P ₀	Sprocket Hole Pitch	4.0 ± 0.1
D ₀	Sprocket Hole Diameter	1.55 ± 0.05
E	Sprocket Hole Location	1.75 ± 0.10
F	Pocket Location	7.5 ± 0.1
P ₂		4.0 ± 0.1
P	Pocket Pitch	12.0 ± 0.1
A ₀	Pocket Dimensions	10.30 ± 0.20
B ₀		10.30 ± 0.20
K ₀		4.90 ± 0.20
W ₁	Cover Tape Width	1.6 ± 0.1
d	Cover Tape Thickness	0.1 max
	Max. Component Rotation or Tilt	10°
R	Min. Bending Radius	30

Reflow Profile

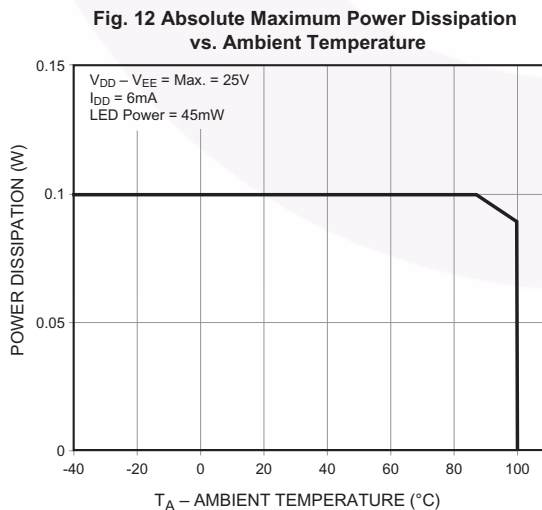


- Peak reflow temperature: 260C (package surface temperature)
- Time of temperature higher than 183C for 160 seconds or less
- One time soldering reflow is recommended

Output Power Derating

The maximum package power dissipation is 295mW. The package is limited to this level to ensure that under normal operating conditions and over extended temperature range that the semiconductor junction temperatures do not exceed 125°C. The package power is composed of three elements; the LED, static operating power of the output IC, and the power dissipated in the output power MOSFET transistors. The power rating of the output IC is 250mW. This power is divided between the static power of the integrated circuit, which is the product of I_{DD} times the power supply voltage ($V_{DD} - V_{EE}$). The maximum IC static output power is 150mW, ($V_{DD} - V_{EE}$) = 25V, I_{DD} = 6mA. This maximum condition is valid over the operational temperature range of -40°C to +100°C. Under these maximum operating conditions, the output of the power MOSFET is allowed to dissipate 100mW of power.

The absolute maximum output power dissipation versus ambient temperature is shown in Figure 12. The output driver is capable of supplying 100mW of output power over the temperature range from -40°C to 87°C. The output derates to 90mW at the absolute maximum operating temperature of 100°C.

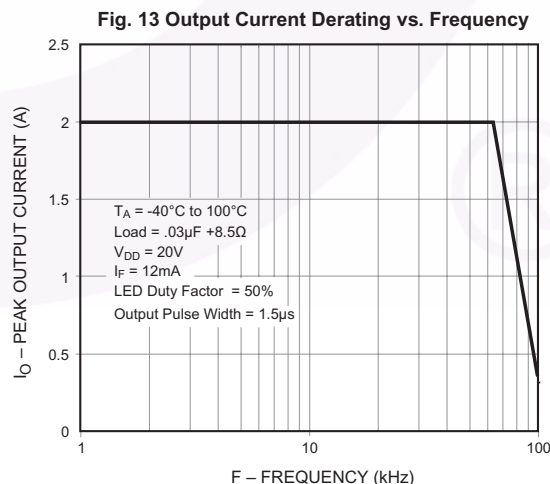


The output power is the product of the average output current squared times the output transistor's $R_{DS(ON)}$:

$$P_{O(AVG)} = I_{O(AVG)}^2 \cdot R_{DS(ON)}$$

The $I_{O(AVG)}$ is the product of the duty factor times the peak current flowing in the output. The duty factor is the ratio of the 'on' time of the output load current divided by the period of the operating frequency. An $R_{DS(ON)}$ of 2.0Ω results in an average output load current of 200mA. The load duty factor is a ratio of the average output time of the power MOSFET load circuit and period of the driving frequency.

The maximum permissible, operating frequency is determined by the load supplied to the output at its resulting output pulse width. Figure 13 shows an example of a 0.03μF gate to source capacitance with a series resistance of 8.50Ω. This reactive load results in a composite average pulse width of 1.5μs. Under this load condition it is not necessary to derate the absolute maximum output current until the frequency of operation exceeds 63kHz.





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

Build it Now™	FPS™	PDP SPM™	The Power Franchise®
CorePLUS™	F-PFS™	Power-SPM™	the power franchise
CorePOWER™	FRFET®	PowerTrench®	TinyBoost™
CROSSVOLT™	Global Power Resource SM	Programmable Active Droop™	TinyBuck™
CTL™	Green FPS™	QFET®	TinyLogic®
Current Transfer Logic™	Green FPS™ e-Series™	QS™	TINYOPTO™
EcoSPARK®	GTO™	Quiet Series™	TinyPower™
EfficientMax™	IntelliMAX™	RapidConfigure™	TinyPWM™
EZSWITCH™ *	ISOPLANAR™	Saving our world, 1mW at a time™	TinyWire™
	MegaBuck™	SmartMax™	μSerDes™
	MICROCOUPLER™	SMART START™	
Fairchild®	MicroFET™	SPM®	UHC®
Fairchild Semiconductor®	MicroPak™	STEALTH™	Ultra FRFET™
FACT Quiet Series™	MillerDrive™	SuperFET™	UniFET™
FACT®	MotionMax™	SuperSOT™3	VCX™
FAST®	Motion-SPM™	SuperSOT™6	VisualMax™
FastvCore™	OPTOLOGIC®	SuperSOT™8	
FlashWriter® *	OPTOPLANAR®	SupreMOS™	
		SyncFET™	
			

* EZSWITCH™ and FlashWriter® are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I35



**Стандарт
Электрон
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург,
Промышленная ул, дом № 19, литера Н,
помещение 100-Н Офис 331